CMOS Digital Integrated Circuits Silicon Monolithic

74VHCT240AFT,74VHCT244AFT

1. Functional Description

· Octal Bus Buffer

74VHCT240AFT: INVERTED, 3-STATE OUTPUTS 74VHCT244AFT: NON-INVERTED, 3-STATE OUTPUTS

2. General

The 74VHCT240AFT and 74VHCT244AFT are advanced high speed CMOS OCTAL BUS BUFFERs fabricated with silicon gate C²MOS technology. They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The 74VHCT240AFT is an inverting 3-state buffer having two active-low output enables. The 74VHCT244AFT is a non-inverting 3-state buffer, and has two active-low output enables.

These devices are designed to be used with 3-state memory address drivers, etc.

The input voltage are compatible with TTL output voltage.

These devices may be used as a level converter for interfacing 3.3 V to 5 V system.

Input protection and output circuit ensure that 0 to 5.5 V can be applied to the input and output (Note) pins without regard to the supply voltage. These structure prevents device destruction due to mismatched supply and input/output voltages such as battery back up, hot board insertion, etc.

Note: Output in off-state

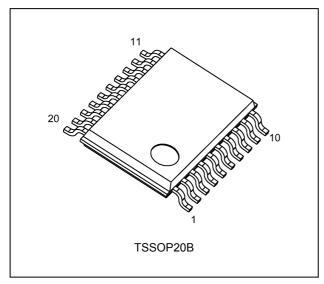
3. Features

- (1) High speed: Propagation delay time = 6.1 ns (typ.) at V_{CC} = 5 V
- (2) Quiescent supply current: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_a = 25 \text{ °C}$
- (3) Compatible with TTL input: $V_{IL} = 0.8 \text{ V(max)}$

$$V_{IH} = 2.0 \text{ V(min)}$$

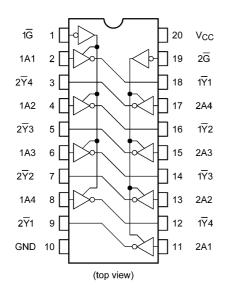
- (4) Power down protection is provided on all inputs and outputs.
- (5) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- (6) Low noise: $V_{OLP} = 1.0 \text{ V (max)}$
- (7) Pin and function compatible with the 74 series (74ACT/HCT/AHCT etc.) 240/244 type.

4. Packaging

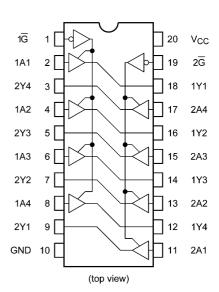


5. Pin Assignment

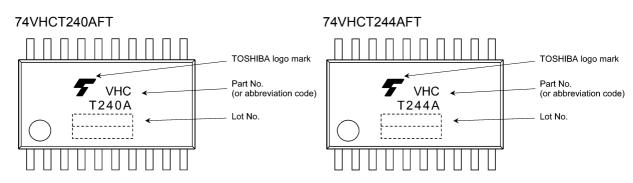
74VHCT240AFT



74VHCT244AFT



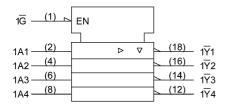
6. Marking

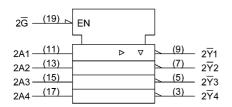




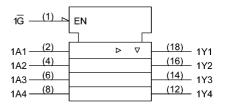
7. IEC Logic Symbol

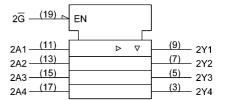
74VHCT240AFT





74VHCT244AFT







8. Truth Table

Input G	Input A _n	Output Y _n	Output \overline{Y}_n
L	L	L	Н
L	Н	Н	L
Н	Х	Z	Z

X: Don't care (L or H)
Z: High impedance Y_n : 74VHCT244AFT \overline{Y}_n : 74VHCT240AFT

9. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 7.0	V
Input voltage	V _{IN}		-0.5 to 7.0	
Output voltage	V _{OUT}	(Note1)	-0.5 to 7.0	
		(Note2)	-0.5 to V _{CC} + 0.5	
Input diode current	I _{IK}		-20	mA
Output diode current	I _{OK}	(Note3)	±20	
Output current	I _{OUT}		±25	
V _{CC} /ground current	Icc		±75	
Power dissipation	P _D		180	mW
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note1: Output in off-state.

Note2: High (H) or Low (L) state. I_{OUT} absolute maximum rating must be observed.

Note3: V_{OUT} < GND, V_{OUT} > _{VCC}

10. Operating Ranges (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		4.5 to 5.5	٧
Input voltage	V _{IN}		0 to 5.5	
Output voltage	V _{OUT}	(Note1)	0 to 5.5	
		(Note2)	0 to V _{CC}	
Operating temperature	T _{opr}		-40 to 85	Ŝ
Input rise and fall times	dt/dv	·	0 to 20	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs and bus inputs must be tied to either V_{CC} or GND.

Note1: Output in OFF state. Note2: High (H) or Low (L) state.



11. Electrical Characteristics

11.1. DC Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage	V_{IH}	_		4.5 to 5.5	2.0	_		V
Low-level input voltage	V_{IL}	_		4.5 to 5.5	_	_	0.8	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	4.5	4.40	4.50		
			I_{OH} = -8 mA	4.5	3.94	_		
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	4.5		0.0	0.10	
			I _{OL} = 8 mA	4.5	_	_	0.36	
3-state output OFF-state leakage current	I _{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$		5.5	_	_	±0.25	μА
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND	V _{IN} = 5.5 V or GND		_	_	±0.1	
Quiescent supply	I _{CC}	V _{IN} = V _{CC} or GND		5.5	_	_	4.0	
current	I _{CCT}	Per input :V _{IN} = 3.4V Other input:V _{CC} or GND		5.5	_	_	1.35	mA
Output leakage current (Power-OFF)	I _{OPD}	V _{OUT} = 5.5 V		0	_	_	0.5	μА

11.2. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		4.5 to 5.5	2.0	_	V
Low-level input voltage	V _{IL}	_		4.5 to 5.5	_	0.8	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	4.5	4.4	_	
			I _{OH} = -8 mA	4.5	3.80	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I_{OL} = 50μ A	4.5	_	0.1	
			I _{OL} = 8 mA	4.5	_	0.44	
3-state output OFF-state leakage current	I _{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$			_	±2.50	μА
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND			_	±1.0	
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		5.5	_	40.0	
Quiescent supply current	I _{CCT}	Per input: V _{IN} = 3.4 V, other input: V _{CC} or GND		5.5	_	1.50	mA
Output leakage current (Power-OFF)	I _{OPD}	V _{OUT} = 5.5 V	, 55		_	5.0	μА



11.3. AC Characteristics (Unless otherwise specified, T_a = 25 °C, Input: t_r = t_f = 3 ns)

Characteristics	Part Number	Symbol	Note	Test Condition	V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Unit
Propagation delay time	74VHCT240AFT	t _{PLH} ,t _{PHL}		_	5.0 ± 0.5	15	_	5.6	7.8	ns
						50	_	6.1	8.8	
	74VHCT244AFT	t _{PLH} ,t _{PHL}		_	5.0 ± 0.5	15	_	5.4	7.4	
						50	_	5.9	8.4	
3-state output enable time		t _{PZL} ,t _{PZH}		$R_L = 1 k\Omega$	5.0 ± 0.5	15	_	7.7	10.4	
						50	_	8.2	11.4	
3-state output disable time		t_{PLZ}, t_{PHZ}		$R_L = 1 k\Omega$	5.0 ± 0.5	50	_	8.8	11.4	
Output skew		t _{osLH} ,t _{osHL}	(Note 1)	_	5.0 ± 0.5	50	_	_	1.0	
Input capacitance		C _{IN}		_			_	4	10	pF
Output capacitance		C _{OUT}		_			_	9	_	
Power dissipation capacitance	74VHCT240AFT	C _{PD}	(Note 2)	_			_	19	_	
Power dissipation capacitance	74VHCT244AFT	C_{PD}	(Note 2)	_			_	18		pF

Note 1: Parameter guaranteed by design. $(t_{osLH} = |t_{PLHm} - t_{PLHn}|, t_{osHL} = |t_{PHLm} - t_{PHLn}|)$

Note 2: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation. $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{|N} + I_{CC}/8 \text{ (per bit)}$

11.4. AC Characteristics

(Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Part Number	Symbol	Note	Test Condition	V _{CC} (V)	C _L (pF)	Min	Max	Unit
Propagation delay time	74VHCT240AFT	t_{PLH}, t_{PHL}		_	5.0 ± 0.5	15	1.0	9.0	ns
						50	1.0	10.0	
	74VHCT244AFT	t_{PLH}, t_{PHL}		_	5.0 ± 0.5	15	1.0	8.5	
						50	1.0	9.5	
3-state output enable time		t_{PZL}, t_{PZH}		$R_L = 1 k\Omega$	5.0 ± 0.5	15	1.0	12.0	
						50	1.0	13.0	
3-state output disable time		t_{PLZ}, t_{PHZ}		$R_L = 1 k\Omega$	5.0 ± 0.5	50	1.0	13.0	
Output skew		t_{osLH}, t_{osHL}	(Note 1)		5.0 ± 0.5	50		1.0	
Input capacitance		C _{IN}		_			_	10	pF

Note 1: Parameter guaranteed by design. $(t_{osLH} = |t_{PLHm} - t_{PLHn}|, t_{osHL} = |t_{PHLm} - t_{PHLn}|)$

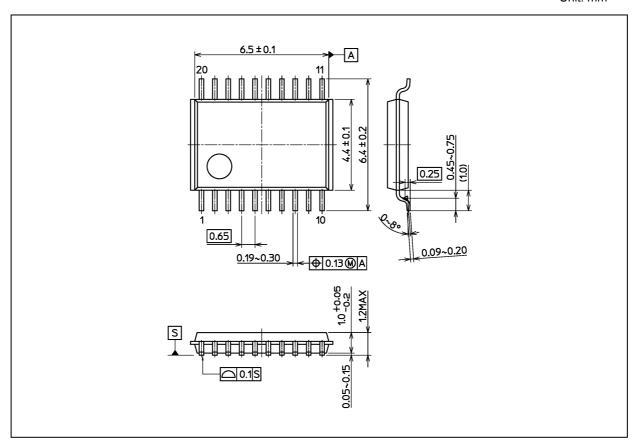
11.5. Noise Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Limit	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	C _L = 50 pF	5.0	0.8	1.0	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	C _L = 50 pF	5.0	-0.8	-1.0	
Minimum high-level dynamic input voltage	V _{IHD}	C _L = 50 pF	5.0		2.0	
Maximum low-level dynamic input voltage	V_{ILD}	C _L = 50 pF	5.0		0.8	



Package Dimensions

Unit: mm



Weight: 0.071 g (typ.)

	Package Name(s)
Nickname: TSSOP20B	



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